



Connectors > Socket Connectors > IC & Component Socket Accessories > Heat Sinks



Device Type: SFP+

Features

Product Type Features

Device Type	SFP+
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Body Features

Primary Product Material	Stainless Steel
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Product Compliance

[For compliance documentation, visit the product page on TE.com>](#)

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE 2023 (235) Does not contain REACH SVHC
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Not applicable for solder process capability

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: <https://echa.europa.eu/guidance-documents/guidance-on-reach>

Compatible Parts

TE Part # CAT-C11-H50626
SFP+ to SFP+ I/O Cable Assembly: 30 AWG

TE Part # 2170488-6
HEAT SINK

TE Part # 1542924-2
HEATSINK SFP ROUND PIN FIN.

TE Part # 1963856-2
CFP HS Kit StS Airflow, 22 fin, 10.3mm

TE Part # CAT-C11-H5
SFP+ to SFP+ I/O Cable Assembly: 24 AWG

TE Part # CAT-C11-H506
SFP+ to SFP+ I/O Cable Assembly: 26 AWG

TE Part # CAT-C11-H5062
SFP+ to SFP+ I/O Cable Assembly: 28 AWG

TE Part # 1963856-1
CFP HS Kit StS Airflow, 38 fin, 10.3mm

TE Part # 1829904-3
HEAT SINK SFP DWDM 6.5mm TALL

TE Part # 2170202-2
XFP HEATSINK

TE Part # 2170448-1
SFP+, HEATSINK, 4.0MM

TE Part # 2170448-3
SFP+, HEATSINK, 8.0MM

TE Part # 2142970-1
CABLE ASSY, MICRO SFP+ TO STD SFP+, 0.5M

TE Part # 2142970-2
CABLE ASSY, MICRO SFP+ TO STD SFP+, 1M

TE Part # 2142970-3
CABLE ASSY, MICRO SFP+ TO STD SFP+, 2M

TE Part # 2142970-4
CABLE ASSY, MICRO SFP+ TO STD SFP+, 3M

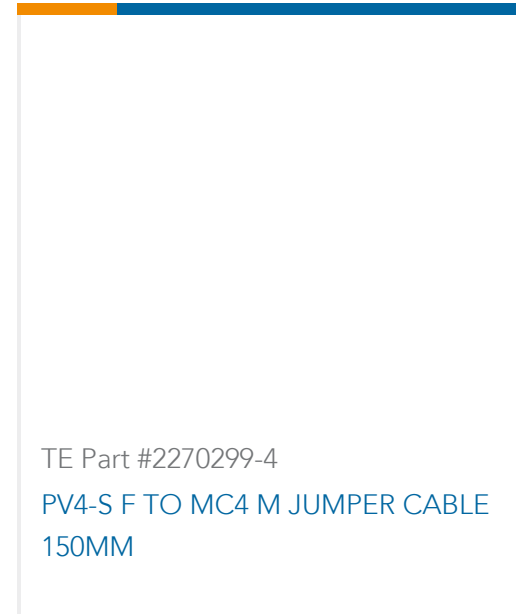
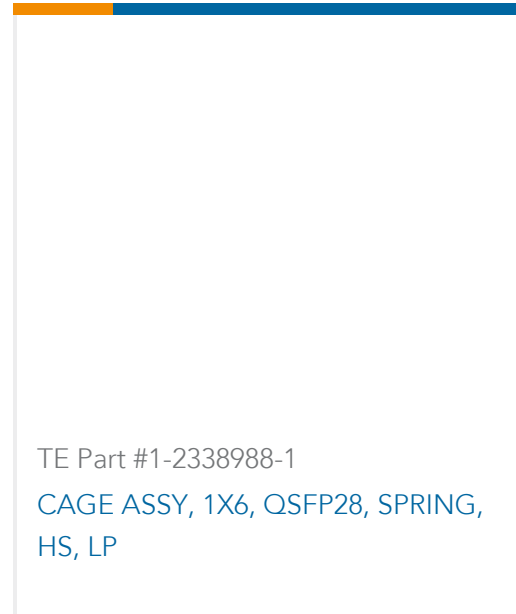
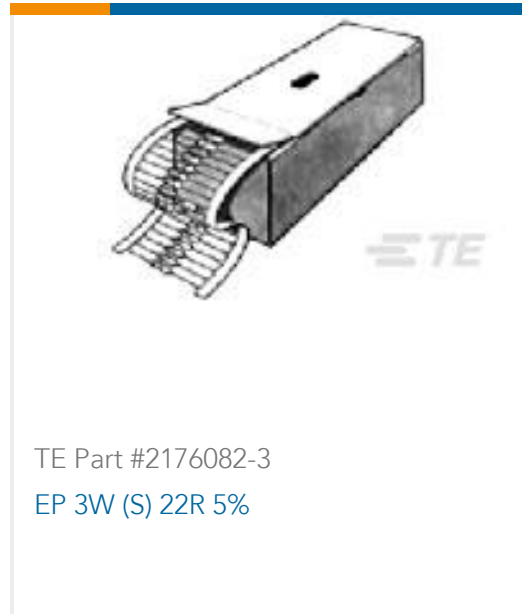
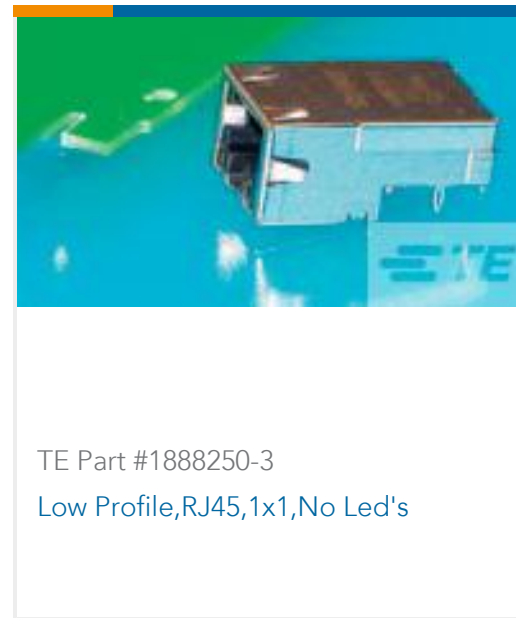
TE Part # 2142970-5
CABLE ASSY, MICRO SFP+ TO STD SFP+, 4M

TE Part # 2142970-6
CABLE ASSY, MICRO SFP+ TO STD SFP+, 5M

TE Part # 2142970-7
CABLE ASSY, MICRO SFP+ TO STD SFP+, 6M

TE Part # 1963838-2
GANGED QSFP PCI EXTRUSION HS 4.2mm TALL

Customers Also Bought



Documents

Product Drawings

Heat Sink Clip, Ganged SFP+

English

CAD Files

3D PDF

3D

Customer View Model

[ENG_CVM_CVM_2169851-1_A.2d_dxf.zip](#)

English

Customer View Model

[ENG_CVM_CVM_2169851-1_A.3d_igs.zip](#)

English

Customer View Model

[ENG_CVM_CVM_2169851-1_A.3d_stp.zip](#)

English

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Product Specifications

Application Specification

English

Product Environmental Compliance

[MD_2169851-1_08112016128_dmtec](#)

English

[MD_2169851-1_08112016128_dmtec](#)

English

